

## **AISthesis Products**

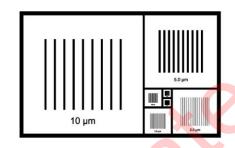
Advanced Imaging Products for Nanotechnology, Engineering and Life Sciences PO Box 1950, Clyde NC 28721





## Wafer Level Certificate of Traceability for Pelcotec™ Critical Dimension Magnification Standard





Product Number: Pelcotec™ 692-01 CDMS-0.1T-ISO

<u>Product Description:</u> 2.5x2.5mm, **Pelcotec™** 2mm-100nm Critical Dimension Magnification Standard

Wafer Identifier: CD-AI05

As Received Condition: New

As Returned Condition: N/A

Date of Receipt: N/A

Customer name and contact information:



P.O. Box 492477

Redding, CA 96049-2477

Tel: 530.243.2200

www.tedpella.com

The accuracy of this product with Wafer Identifier CD-AI05 was determined using a Field Emission Scanning Electron Microscope (FE-SEM) by reference comparison to working standards traceable to the National Institute of Standards and Technology (NIST), using CP 01 FE-SEM Imaging of Critical Dimension Magnification Standards (CDMS) and CP 02 Certification of Critical Dimension Magnification Standards. Die were sampled according to method SOP 07 Sampling Die. The data applies only to the CDMS products identified in this report. All results are "as-is". Repair and/or adjustments are not possible.

Below are the ISO 17025:2017 Accredited Average 10 µm Pitch Measurements unique to Die with Wafer Identifier CD-AI05 and traceable to NIST Certified Standard CD-PG01-0211.

Line	ISO 17025:2017 Accredited	Position of Measurement	
10	Average Pitch on Wafer		
0-10 µm	10.005 μm	± 7.5 µm from center	
1 <mark>0</mark> -20 μm	10.003 μm	± 7.5 µm from center	
20-30 μm	10.005 μm	± 7.5 µm from center	
30-40 μm	10.003 μm	± 7.5 µm from center	
40-50 µm	10.005 μm	± 7.5 µm from center	
50-60 µm	10.003 μm	± 7.5 µm from center	
60-70 μm	10.005 μm	± 7.5 µm from center	
70-80 µm	10.003 μm	± 7.5 µm from center	

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Sum	80.032
Average	10.0040 µm
2-Sigma *	0.0062 µm

\* Corrected for sample size using the appropriate Student t-factor.

Measurements are reported with an uncertainty  $(k=2)^{**}$  of  $\pm$  0.012  $\mu$ m. Statements of Conformity are not provided in this report. Review the results and verify that they meet the requirements for the intended use. Physical damage to or contamination of the CDMS occurring after calibration may invalidate the reported measurements. Use this product at 25°C  $\pm$  5°C and at less than 80% RH.

Below are the Non-ISO 17025:2017 Accredited Average Pitch Measurements unique to Die with Wafer Identifier CD-AI05 and traceable to NIST Certified Standard CD-PG01-0211.

Line	Number of Lines	Position of Measurement	Non-ISO 17025:2017 Accredited Average Measured Distance (first to last line)	Non-ISO 17025:2017 Accredited Average Pitch of Wafer
2.0 mm	2	± 1.00mm from center	2.000 mm	2.000 mm
1.0 mm	2	± 0.5mm from center	1.000 mm	1.000 mm
0.5 mm	2	± 0.25mm from center	0.500 mm	0.500 mm
0.25 mm	2	± 0.125mm from center	0.250 mm	0.250 mm
5.0 µm	12	± 20 µm from center	55.025 μm	5.002 µm
2.0 µm	16	± 10 µm from center	30.059 µm	2.004 µm
1.0 µm	17	± 5 µm from center	16.011 µm	1.001 µm
500 nm	20	± 4 µm from center	9.480 µm	498.9 nm
250 nm	21	± 2.5 µm from center	4.990 μm	249.5 nm
100 nm	52	± 2.5 µm from center	5.092 µm	99.8 nm

The average pitch is derived from the stated length that was determined using measurements (taken center-to-center) over the stated number of lines (i.e., length divided by the number of lines minus one).

Date of Analysis: December 2nd, 2024

## Equipment used:

Instrument	Model	Serial #	Resolution	Repeatability	Temperature	Humidity	Reference
FE-SEM	FEI Apreo 2	9958357	0.9nm	0.030%	23.3 ± 0.3 °C	42.5 ± 1.5%	CD-PG01-0211

Location: AISthesis Products, Inc., PO Box 1950, Clyde North Carolina 28721.

## Notes:

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<sup>\*\*</sup> Reported uncertainties represent expanded uncertainties expressed at approximately the 95% confidence level using a coverage factor of k = 2. The reported expanded measurement uncertainty is stated as the standard measurement uncertainty multiplied by the coverage factor K such that the coverage probability corresponds to approximately 95%.

D.S. Finch Certified by	Signature	
H. Haehlen Authorized by	Signature	December 2 <sup>nd</sup> , 2024 Date report issued.

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End of report.

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